

TLI4970-D025T4

High precision miniature coreless magnetic current sensor for AC and DC measurements with digital interface and fast overcurrent detection

Data Sheet

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1 Product Description



1.1 Overview

The TLI4970-D025T4 is a highly accurate coreless magnetic current sensor. Thus, the output signal is highly linear and without hysteresis. However, a differential measurement principle allows effective stray field suppression. Due to the integrated primary conductor (current rail), there is no need for external calibration. Additionally, a separate interface pin (OCD) provides a fast output signal in case a current exceeds a pre-set threshold. A small leadless package (QFN-like) allows for standard SMD assembly.

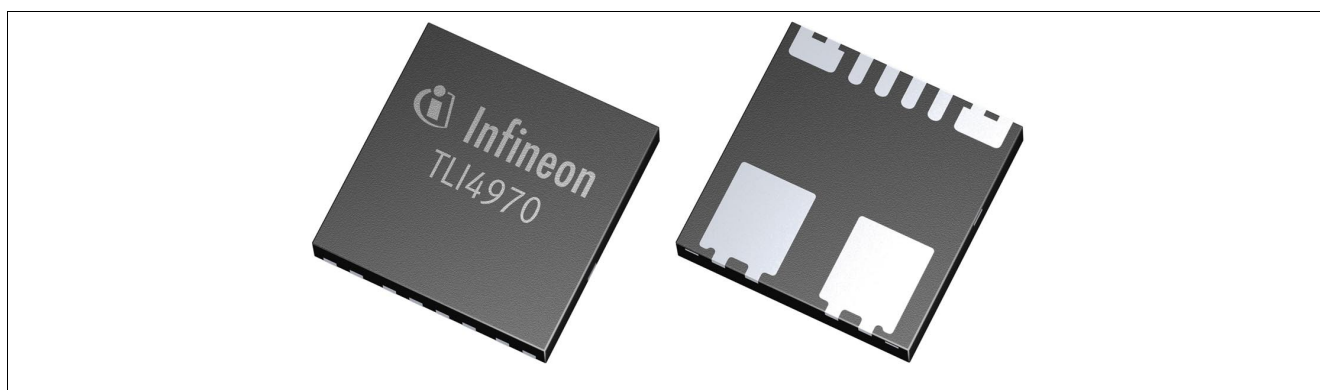


Figure 1-1 TLI4970-D025T4 device in PG-TISON-8-1 package

1.2 Features

- AC & DC measurement range up to ± 25 A
- Highly accurate over temperature range and lifetime
max. 1.0 % (0 h), max. 1.6 % (over lifetime) of indicated value
- Low offset error (max. 25 mA at room temperature)
- High magnetic stray field suppression
- Fast over current detection with configurable threshold
- Galvanic isolation up to 2.5 kV max. rated isolation voltage (according to UL 1577)
- 16 bit digital SPI output (13 bit current value)
- Small 7 mm x 7 mm SMD package

Table 1-1 Order Information

Product Name	Product Type	Package	Ordering Number
TLI4970-D025T4	Qualified according to industrial standards: For use in industrial / consumer applications	PG-TISON-8-1	SP001323154

1.3 General Information

The TLI4970-D025T4 is a high-precision digital current sensor. The full scale measurement range is ± 25 A. The sensor is based on Infineon's well-established and robust Hall technology.

The measurement principle allows galvanic isolation (functional isolation) between the primary conductor and the secondary interface side.

The coreless concept without a flux concentrator allows significant miniaturization. It shows no hysteresis effects and has enhanced linearity and over current capability compared to existing solutions. The differential measurement principle achieves best-in-class suppression of magnetic stray fields. The sensor is fully calibrated; no need for any additional calibration after PCB assembly is necessary. Thus, the overall implementation effort and costs are significantly reduced. It is a plug-and-play solution, easy to use in industrial and consumer applications.

The accuracy of the TLI4970-D025T4 is comparable to closed-loop current measurement systems and even better than open-loop systems with magnetic core. But in comparison to the open- and closed-loop system the TLI4970-D025T4 enables a significantly smaller footprint and less power consumption.

Infineon's patented stress compensation circuit provides outstanding long-term stability of the output signal. Proprietary dynamic offset cancellation techniques guarantee particularly low zero point error. Hereby, the TLI4970-D025T4 offers superior performance.

The TLI4970-D025T4 is based on a digital concept. Thus, signal processing, compensation and calibration is already integrated. No further external measurements for compensation are needed.

The sensor is provided in a small 7 mm x 7 mm SMD package.

1.4 Target Applications

The TLI4970-D025T4 is suitable for AC as well as DC current measurement applications:

- Current monitoring
- Chargers
- Photovoltaic & general purpose inverters
- Power supplies (SMPS)
- Electrical drive
- etc.

With its implemented magnetic interference suppression, it is extremely robust when exposed to external magnetic fields. It is also suitable for fast over current detection with a configurable threshold level. This allows the control unit to switch off and protect the affected system from damage, independently of the main measurement path.

2 Functional Description

2.1 Pin Configuration

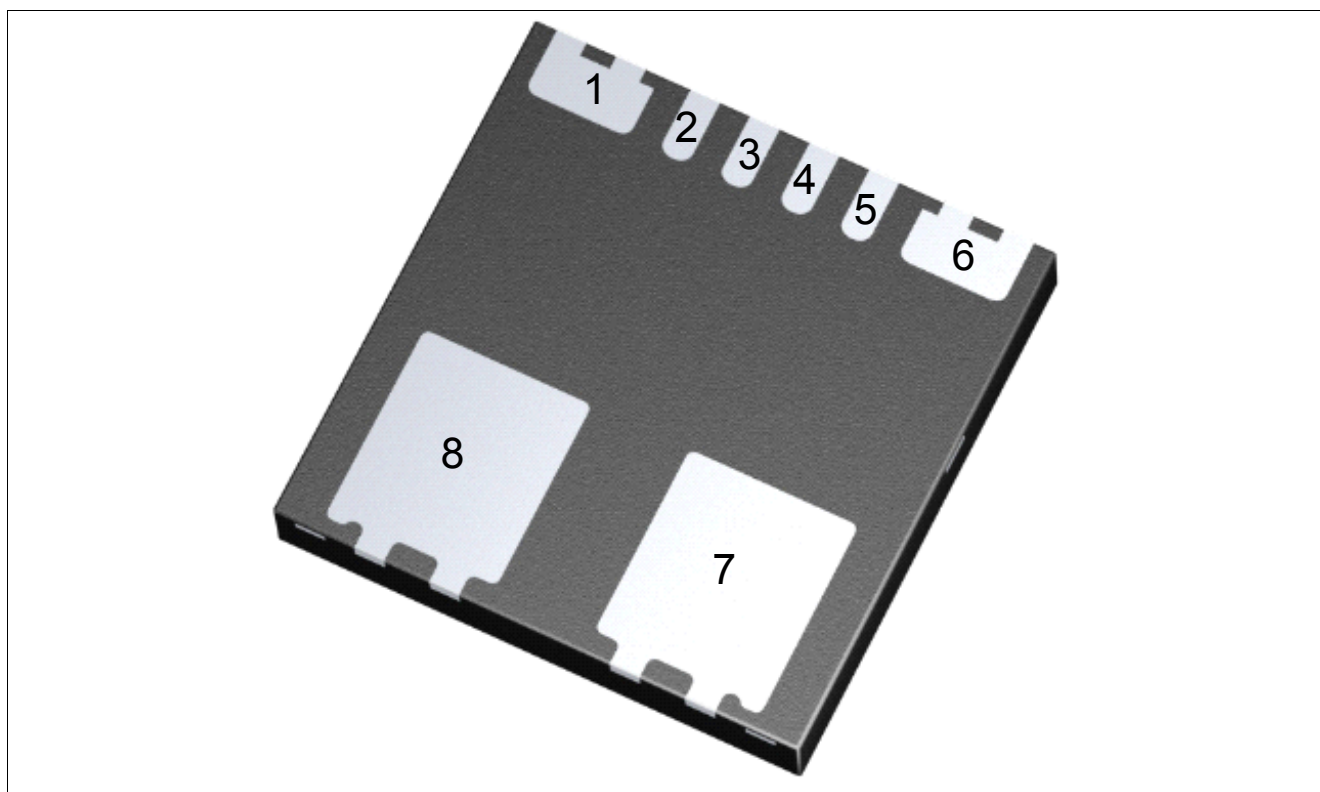


Figure 2-1 Pin configuration PG-TISON-8-1

Table 2-1 Pin Definition and Function

Pin No.	Symbol	Function
1	GND	Ground
2	VDD	Supply voltage
3	DOUT	SPI data out
4	SCLK	Serial clock input
5	$\overline{\text{CS}}$	Chip select input (low-active)
6	OCD	Over current detection output (open drain output)
7	IP+	Positive current terminal pin (current-in)
8	IP-	Negative current terminal pin (current-out)

2.2 Block Diagram

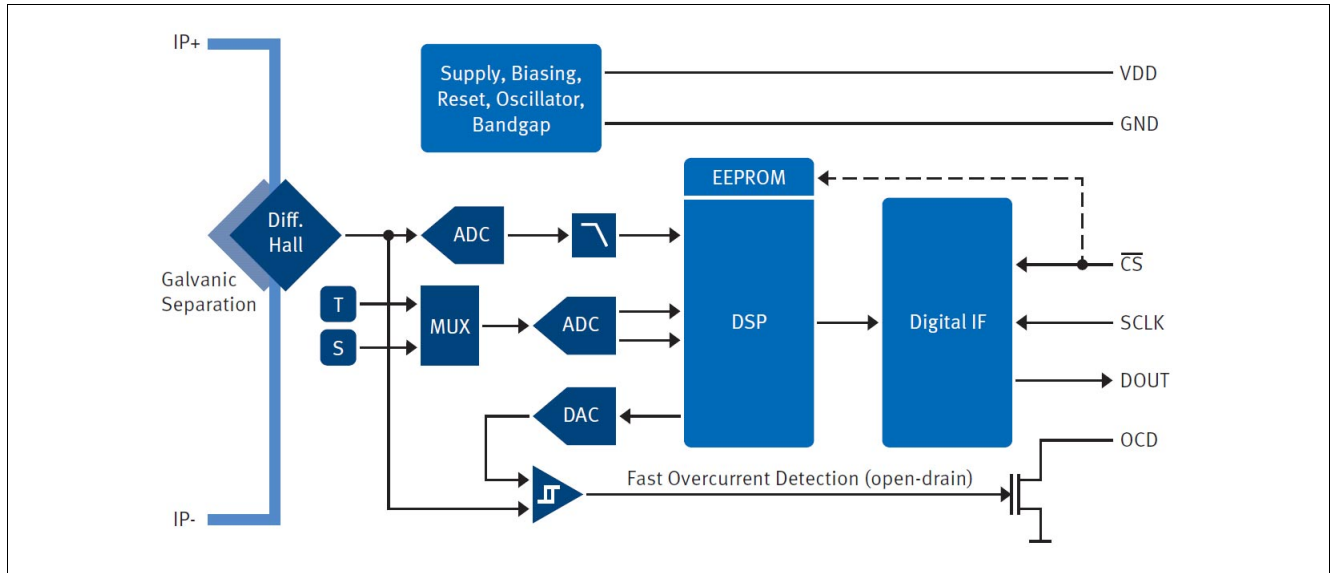


Figure 2-2 Functional block diagram of the TLI4970-D025T4

2.3 Functional Description

The current, flowing through the current rail on the primary side, induces a magnetic field. This is measured by two differential Hall probes. The signal from the two Hall probes is directly digitalized by a Sigma-Delta-A/D converter (ADC). After the programmable digital low-pass filter, the raw current signal is fed into the DSP. The differential measurement principle of the magnetic field provides a very good suppression of any ambient magnetic stray fields.

The temperature (T) and the mechanical stress (S) of the chip are measured and converted independently of the primary current by a second ADC. The Digital Signal Processing Unit (DSP) uses both temperature and stress information to compensate the raw current signal according to internally stored calibration tables. The interface unit (IF) transmits the fully compensated value via the SPI interface.

Furthermore several parameters like low pass filter settings or over current detection (OCD) levels can be programmed via a **S**erial **I**nspection and **C**onfiguration Interface (SICI) which are described in the TLI4970 programming guide.

For fast over current detection, the raw analog signal from the Hall probes is fed into a programmable comparator. This comparator has a programmable glitch filter to suppress fast switching transients in the signal and to avoid false triggers. The open-drain output of the OCD-Pin allows readout of over current signals for several TLI4970-D025T4 sensors by only one microcontroller input pin.

2.4 Transfer Function

The transfer function is given by the formula shown in [Figure 2-3](#).

$$I_{out}[A] = \frac{out[LSB_D] - 4096[LSB_D]}{160[\frac{LSB_D}{A}]}$$

$$out[LSB_D] = I[A] \cdot 160[\frac{LSB_D}{A}] + 4096[LSB_D]$$

Figure 2-3 Transfer function formula

The basic point are defined by the value 0_D (-25.6000A) and 8191_D (25.59375A). Outside this current range, the sensor status message will be sent instead of the sensor current message (see [Figure 2-4](#)).

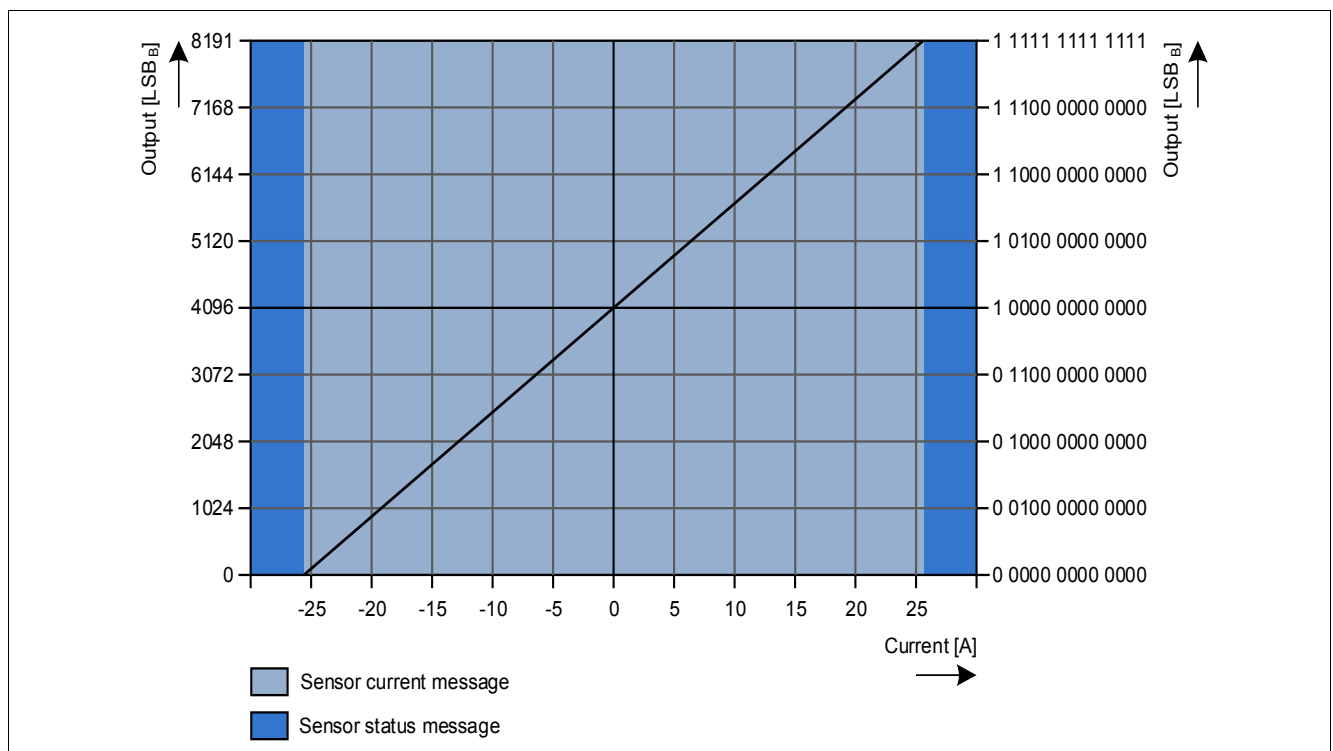


Figure 2-4 Transfer function

2.5 Filter Settings

The transfer function of the TLI4970-D025T4 can be influenced by different filter settings. Finally the combination of a high-pass filter, a prediction filter and a low-pass filter determines the overall transfer function. **Figure 2-5** shows the Bode plots for different filter settings. The filter settings can be changed by EEPROM programming. The manual for EEPROM programming can be found in the TLI4970 programming guide (application note).

Table 2-2 gives an overview about the different filter settings.

Table 2-2 Overview about bandwidth and response time

High-pass filter	Prediction filter	Low-pass filter	Bandwidth	Response time ¹⁾
1	1	7	70 Hz	6.2 ms
1	1	6	130 Hz	3.1 ms
1	1	5	260 Hz	1.6 ms
1	1	4	530 Hz	781 μ s
1	1	3	1.1 kHz	394 μ s
1	1	2	2.4 kHz	201 μ s
1	1	1	5.2 kHz	109 μ s
1	1	0	6.9 kHz	92 μ s
0	0	0	10 kHz	70 μ s
0	1	0	18 kHz	57 μ s

1) 90% of final value based on 25 A step function

Functional Description

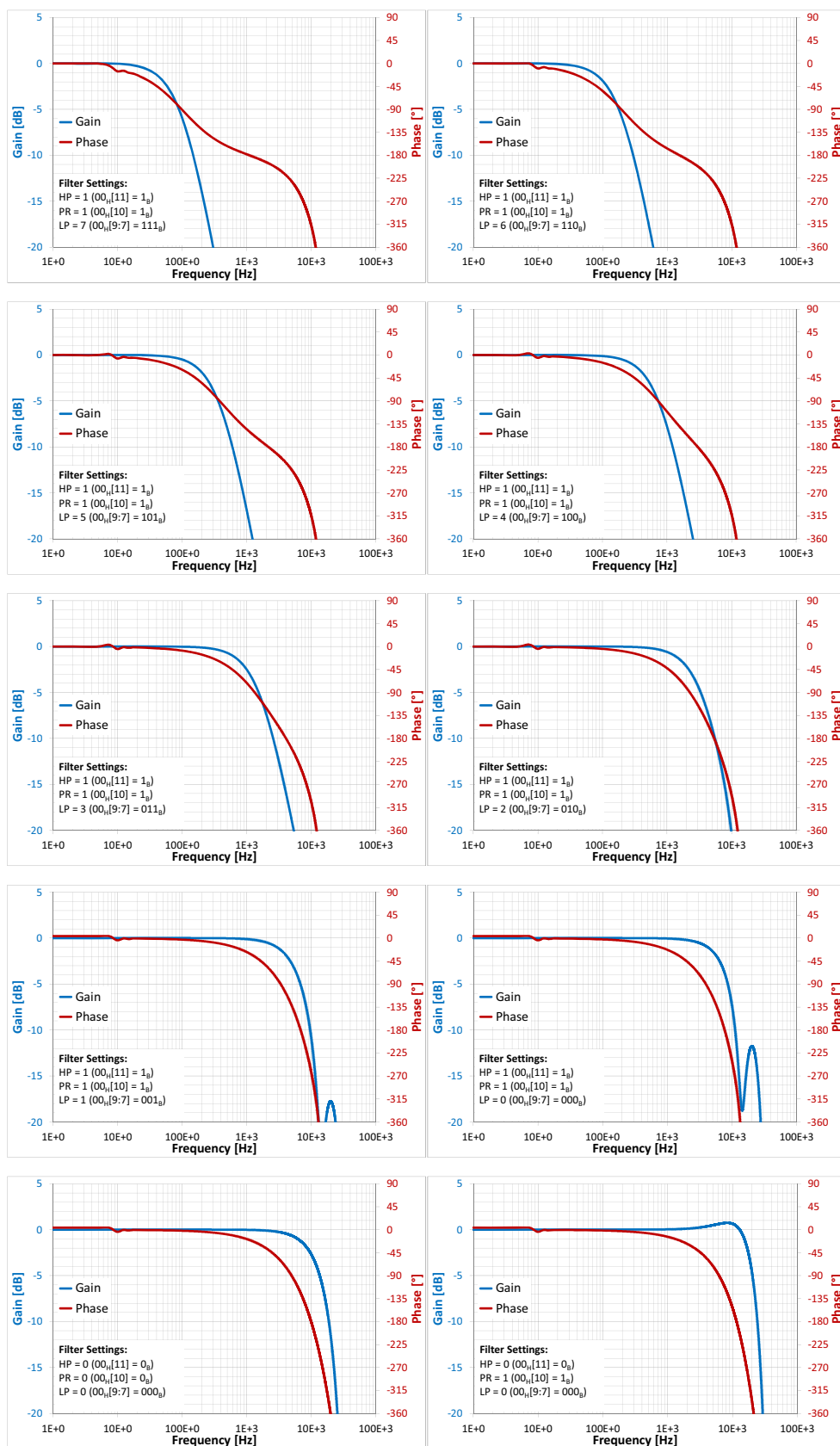


Figure 2-5 Bode plots for different filter settings

2.6 Increased Temperature Range

The max. specified ambient operating temperature of 85°C is limited due to the power dissipation in the current rail. The thermal loss finally increases the junction temperature which has to be limited to 125°C.

Reducing the current through the current rail decreases the thermal loss and therewith a higher ambient operating temperature is possible.

3 Specification

3.1 Absolute Maximum Ratings

Table 3-1 Absolute Maximum Ratings

General conditions (unless otherwise specified): $V_{DD} = 3.3 \text{ V}$; $T_A = -40 \text{ }^{\circ}\text{C} \dots +85 \text{ }^{\circ}\text{C}$

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Supply voltage	V_{DD}	-0.3	-	+3.6	V	
Maximum primary current	I_P	-60	-	+60	A	$T_A = T_{\text{Contact_IP_IN}}^{1)}$
Maximum primary pulse current	I_{P_PULSE}	-	-	150	A	Max. 3 pulses, 200 ms each; tested with 105 μm Cu layer on PCB
Voltage on interface pins DOUT, SCLK & OCD	V_{IO}	-0.3	-	+3.6	V	
Voltage on interface pin $\overline{\text{CS}}$	V_{IO_CS}	-0.3	-	+21.0	V	
ESD voltage ²⁾	V_{ESD_HBM}	-	-	± 2	kV	
Maximum junction temperature	T_{J_max}	-	-	+125	$^{\circ}\text{C}$	
Storage temperature	T_{A_STORE}	-40	-	+125	$^{\circ}\text{C}$	Not connected

1) $T_{\text{Contact_IP_IN}}$: Temperature of current rail on PCB at solder joint.

2) According to standard EIA / JESD22-A114-E Human Body Model (HBM)

Attention: Stresses above the limit values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.

3.2 Operating Conditions

Table 3-2 Electrical Operating Parameters

General conditions (unless otherwise specified): $V_{DD} = 3.3 \text{ V}$; $T_A = -40 \text{ }^{\circ}\text{C} \dots +85 \text{ }^{\circ}\text{C}$

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Supply voltage	V_{DD}	3.1	3.3	+3.5	V	
Voltage on interface pin $\overline{\text{CS}}$	V_{IO_CS}	-0.3	-	+3.6	V	Normal operation
	V_{IO_PROG}	+20.5	-	+20.7	V	Only during programming
Current consumption	I_{DD}	5	12	20	mA	Secondary side
Full-scale primary current measurement range	I_{PFSR}	-25	-	+25	A	

Table 3-2 Electrical Operating Parameters (cont'd)

General conditions (unless otherwise specified): $V_{DD} = 3.3 \text{ V}$; $T_A = -40 \text{ }^{\circ}\text{C} \dots +85 \text{ }^{\circ}\text{C}$

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Primary resistance	R_P	-	0.6	-	m Ω	Resistance of current rail $T_A = 25^{\circ}\text{C}$
		-	-	1.0	m Ω	T_{J_max}
Ambient temperature	T_A	-40	-	+85	$^{\circ}\text{C}$	$T_A = T_{\text{Contact_IP_IN}}^{1)}$

1) $T_{\text{Contact_IP_IN}}$: Temperature of current rail on PCB at solder joint.

Table 3-3 Accuracy Parameters

General conditions (unless otherwise specified): $V_{DD} = 3.3 \text{ V}$; $T_A = -40 \text{ }^{\circ}\text{C} \dots +85 \text{ }^{\circ}\text{C}$

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Relative offset error	ε_{ROE}	-0.1	-	+0.1	% of I_{PFSR}	@ 0A DC & $T_A = 25^{\circ}\text{C}$
		-0.15	-	+0.15	% of I_{PFSR}	@ 0A DC & $T_A = -40^{\circ}\text{C}$
		-0.3	-	+0.3	% of I_{PFSR}	@ 0A DC & $T_A = 85^{\circ}\text{C}$
Absolute offset error	ε_{AOE}	-25.0	-	+25.0	mA	@ 0A DC & $T_A = 25^{\circ}\text{C}$
		-37.5	-	+37.5	mA	@ 0A DC & $T_A = -40^{\circ}\text{C}$
		-75.0	-	+75.0	mA	@ 0A DC & $T_A = 85^{\circ}\text{C}$
Relative total error (gain, offset, linearity) incl. lifetime-drift and whole temperature range ¹⁾	ε_{RTE}	-1.6	-	+1.6	% of I_P	Percentage of indicated value
Absolute total error (gain, offset, linearity) incl. lifetime-drift and whole temperature range ¹⁾	ε_{ATE}	-16.0	-	+16.0	mA/A	Absolute total error proportional to I_P
Update rate	f_{UPDATE}	-	80	-	kSPS ²⁾	
Resolution	G	-	6.25	-	mA / LSB	13-Bit current value via SPI
Noise ³⁾	I_{NOISE}	-	10	-	mA _{RMS}	@ $T_A = 25^{\circ}\text{C}$ & $BW_I = 1.1 \text{ kHz}^{4)}$
Bandwidth of current measurement path	BW_{I_min}	-	70	-	Hz	-3 dB cutoff; see Section 2.5 for filter settings
	BW_{I_max}	-	18	-	kHz	
Power-on time		-	-	15	ms	To stable and accurate output data

1) Valid for soldered parts on PCB based on the footprint recommendation in [Figure 5-3](#) and a copper thickness of 70 μm

2) kSPS: Thousand samples per second

3) Characterized in the laboratory for small signals; $I_P = 0 \text{ mA}$

4) Bandwidth settings will affect noise

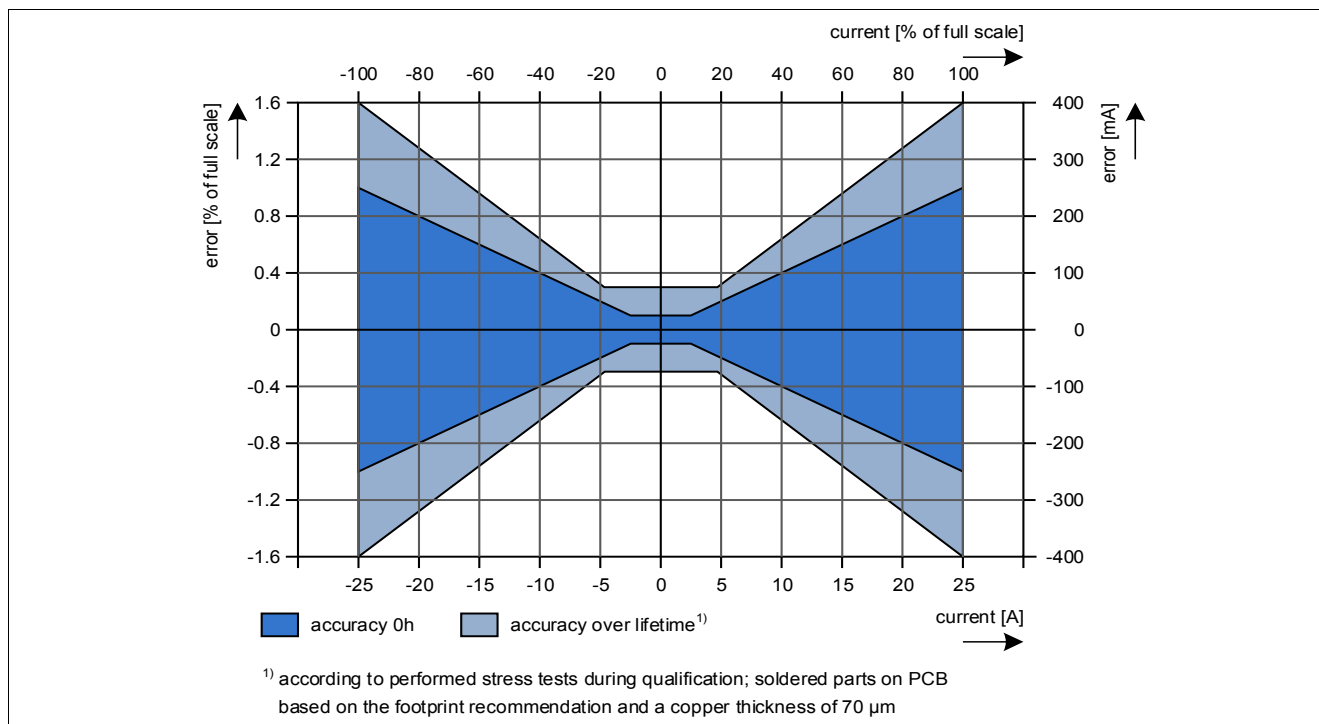


Figure 3-1 Distribution of the maximum total error

3.3 Fast Over Current Output

The Fast Over Current (OCD) pin allows fast detection of an over current in the measurement path. The OCD signal path is independent from the bandwidth limited current signal path and has a programmable glitch filter to avoid false triggers by noise spikes on the current rail. The symmetric threshold level of the OCD output is adjustable and triggers an over current event in case of a positive or negative over current.

In addition a zero-crossing functionality can be programmed (in this case the over current detection is disabled).

If connected via an external pull-up resistor to a logic input pin of the microcontroller, it can be used to trigger an interrupt in the microcontroller and quickly shut off the system to avoid damage from the over current event. The OCD pin has an open-drain output that allows monitoring of several current sensors via only one microcontroller input pin. For details, please refer to the application circuit shown in [Figure 3-2](#).

The instruction for the settings can be found in the TLI4970 programming guide.

Table 3-4 OCD Output Parameter

General conditions (unless otherwise specified): $V_{DD} = 3.3 \text{ V}$; $T_A = -40 \text{ }^{\circ}\text{C} \dots +85 \text{ }^{\circ}\text{C}$

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Threshold level ¹⁾	I_{THR}	6	-	90	A	Programmable (EEPROM)
Accuracy	X_{OCD}	-	20	-	% I_{PFSR}	
Response time of fast over current detection ²⁾³⁾	t_{D_OC}	-	1.8	3.5	μs	Only valid for $\Delta I / \Delta t < 500 \text{ kA/s}$
Load capacitance	C_L	-	-	1	nF	To GND
Open-drain current	I_{OD_on}	-	-	1	mA	Resistive to V_{DD} ; $V_{OD_on} \leq 0.2 \times V_{DD}$
Pull-up resistor	R_{PU}	4.7	-	-	k Ω	To V_{DD}

1) Symmetric threshold level for positive and negative currents

2) Falling edge level of OCD-pin $< 0.5V_{DD}$

3) Characterized in lab under worst case test conditions: $R_{PU} = 4.7\text{k}\Omega$ to V_{DD} ; $C_L = 1 \text{ nF}$ to GND

3.4 Application Circuit

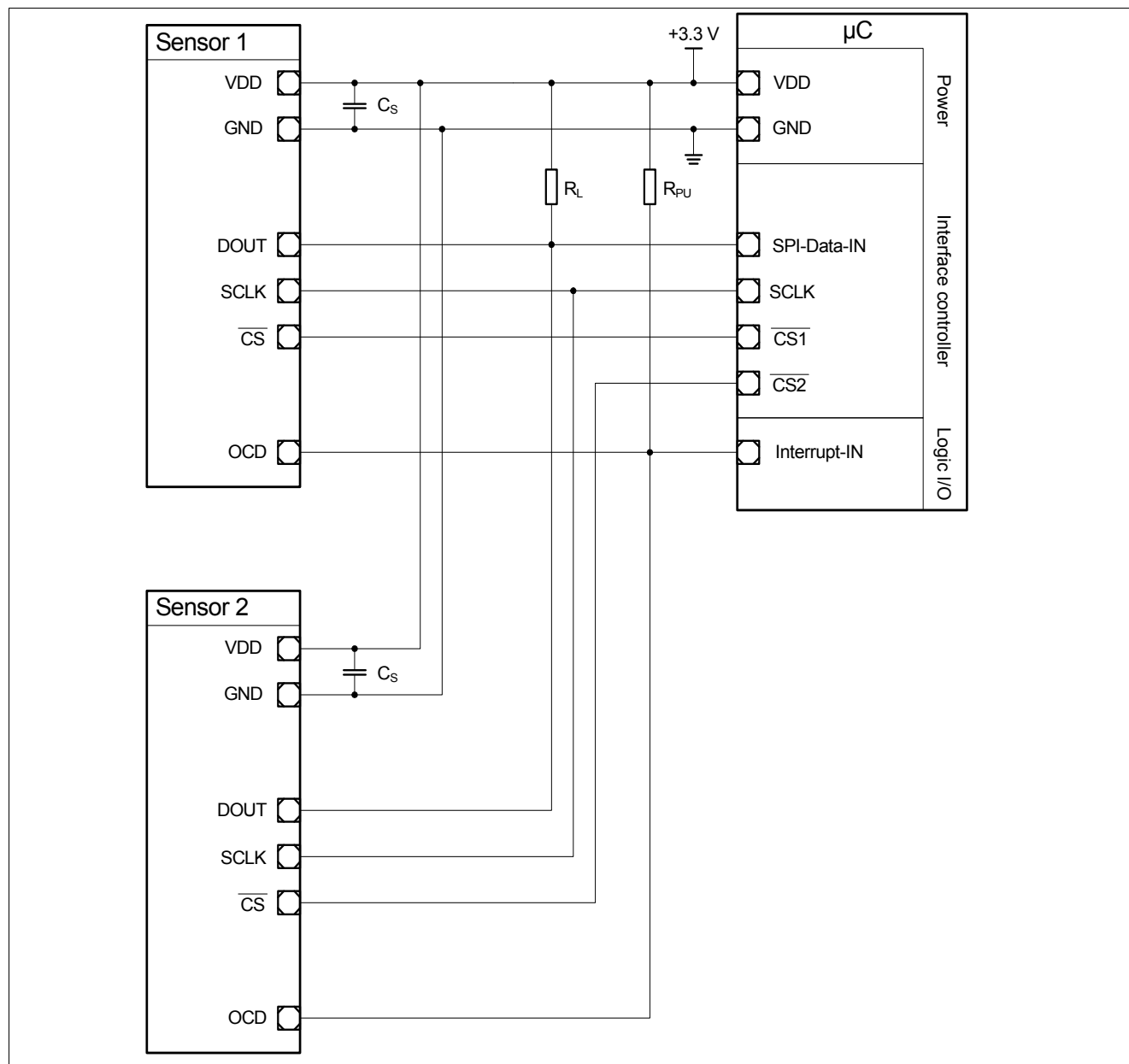


Figure 3-2 Application circuit for readout of multiple sensors in parallel bus mode

Table 3-5 Typical Application Values

Name	Value
R_{PU}	47 k Ω
R_L	100 k Ω
C_S	100 nF

3.5 Isolation Characteristics

The TLI4970-D025T4 is qualified and tested according IEC and UL standards (functional isolation).

Table 3-6 Isolation Parameters according to IEC 60747-5-2

Description	Symbol	Characteristic	Unit
Maximum rated working voltage (sine wave) ¹⁾²⁾³⁾	U_{IOWM}	424	V_{RMS}
Maximum repetitive isolation voltage (max. DC-voltage) ¹⁾³⁾	U_{IORM}	600	V_{peak}
Maximum transient over voltage ¹⁾³⁾	U_{IOTM}	3600	V_{peak}
Apparent charge test voltage (Method B) ¹⁾³⁾ Partial discharge < 5pC	$U_{pd,b}$	900	V_{peak}
Isolation test voltage (1 sec) ¹⁾	U_{ISO}	2546	V_{RMS}
Maximum surge voltage (1.2 / 50 μs) ¹⁾	U_{IOSM}	3600	V_{peak}
Minimum external creepage distance	CPG	3.0	mm
Minimum external clearance distance	CLR	3.0	mm
Minimum comparative tracking index	CTI	575 (Material group II)	
Isolation resistance, $U_{IO} = 500 V$ ⁴⁾	R_{IO}	$> 10^{10}$	Ω

1) Refer to IEC 60747-5-2 for a detailed description of voltages and partial discharge tests

2) The given value is just an example based on pollution degree 2

3) According to performed stress test (85°C, 85% relative humidity, 1000 h test time & 600 V applied insulation voltage)

4) Not subject to production test - verified by design/characterization

Table 3-7 Isolation Parameters according to UL 1577

Description	Symbol	Characteristic	Unit
Maximum rated isolation voltage (1 min.)	U_{ISO}	2546	V_{RMS}
Isolation test voltage (1 sec)	U_{ISO}	2546	V_{RMS}

4 Interfaces

4.1 SPI Interface Definition

The TLI4970-D025T4 has a 3-pin serial peripheral interface (SPI). A standard unidirectional 16-bit SPI protocol is used. Several sensors can be connected to a parallel SPI bus. An example on how to connect multiple sensors is given in [Figure 3-2](#). The timing parameters are given in [Table 4-1](#).

4.1.1 Logical Interface

All SPI frames are based on a 16-bit word. A parity bit in each SPI frame allows the detection of transmission errors and increases the reliability of the measured data. The transmission of the data is triggered by the $\overline{\text{CS}}$ -pin.

4.1.1.1 Protocol Description

The internal data register is continuously updated with the internal update rate f_{UPDATE} . When $\overline{\text{CS}}$ is pulled to low, the actual value from the data register is written into the SPI output register. Like in standard SPI protocol, the sensor starts to transmit the data when clock pulses are applied to the SCLK pin and the $\overline{\text{CS}}$ -pin is still low. With the next 16 clock pulses, the data word is sent out via the DOUT pin. If more than 16 clock pulses are sent by the SPI-Master and the $\overline{\text{CS}}$ -pin stays low, the sensor sends 0's for all additional clock pulses. If a new sample should be read from the sensor, the $\overline{\text{CS}}$ -pin has to return to the high state for at least the time t_{CSON} before pulling it to low again in order to trigger the next sample readout.

The clock pulses are ignored and the DOUT pin is in high ohmic state, when the $\overline{\text{CS}}$ -pin is in "high" state. Therefore multiple chips can be readout on the same data bus by sequentially selecting the addressed sensor via the $\overline{\text{CS}}$ -pin.

4.1.1.2 Description of the SPI Data Frames

There are two different types of SPI frames sent from the sensor. The "Sensor Status Message" and the "Sensor Value Message". The two types are distinguished by the STATUS Bit. The DATA section contains different information. For details see below.

General structure of the 16-bit SPI data frame

GENERAL		Offset	Reset Value
16-bit SPI data frame		00 _H	4000 _H
15	14	13	0
STAT	PAR	DATA	
r	r	r	

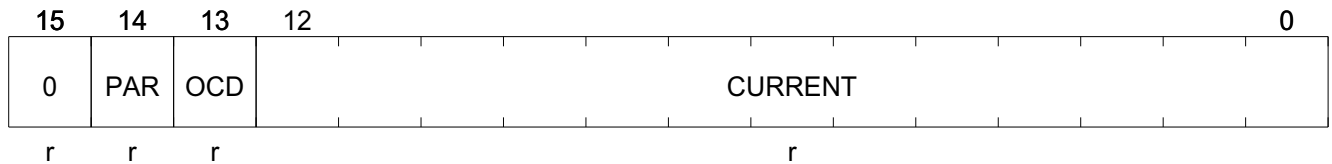
Note: All fields marked as "r" are read-only values.

4.1.1.3 Sensor Current Message

The actual measurement current value is returned in the Sensor Value Message.

Structure of the Sensor Value Message

VALUE	Offset	Reset Value
Value of the actual current measurement	01 _H	4000 _H



Field	Bits	Type	Description
0	15	r	Status Status identifier of a Sensor Value Word
PAR	14	r	Parity Bit Odd parity of current value. This bit is set in a way that the sum of all bits in the Value Word is odd.
OCD	13	r	OCD-state Over current comparator value 0 _B No over current 1 _B Over current detected
CURRENT	12:0	r	Current value Actual measured current value.

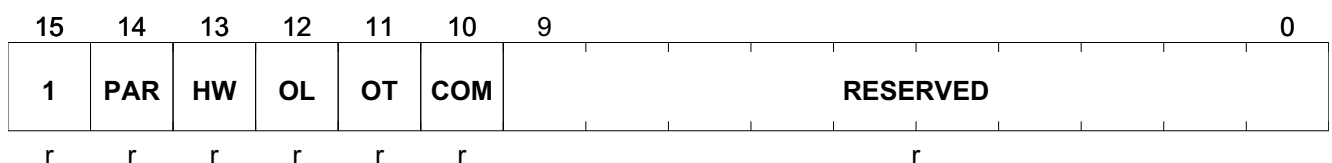
4.1.1.4 Sensor Status Message

The Sensor Status Word contains information about temperature and load conditions and is sent under the following conditions:

- Once after start-up ("Sensor restarted")
- During the sensor start-up phase when a command is sent ("Sensor busy")
- If an internal error occurred ("Sensor fail")

Structure of the Sensor Status Message

STATUS	Offset	Reset Value
Sensor status message	02 _H	8000 _H



Field	Bits	Type	Description
1	15	r	Status Status identifier of a Sensor Status Word
PAR	14	r	Parity Bit Odd parity of current value. This bit is set in a way that the sum of all bits in the Status Word is odd.
HW	13	r	Hardware error 0 _B OK 1 _B Internal error; sensor not usable
OL	12	r	Overload error 0 _B OK 1 _B Overload (Current outside I _{PFSR} range)
OT	11	r	Temperature error 0 _B OK 1 _B Temperature out of range
COM	10	r	Communication error 0 _B OK 1 _B No multiple of 16 SCLK cycles detected in last frame
RESERVED	9:0	r	Reserved Don't care - Reserved for future use

4.1.2 Physical SPI Interface

The TLI4970-D025T4 has a 3-pin unidirectional SPI interface. This interface can be driven with a clock up to 5 MHz. The timing parameters are given in [Table 4-1](#). Electrical characteristics are given in [Table 4-2](#).

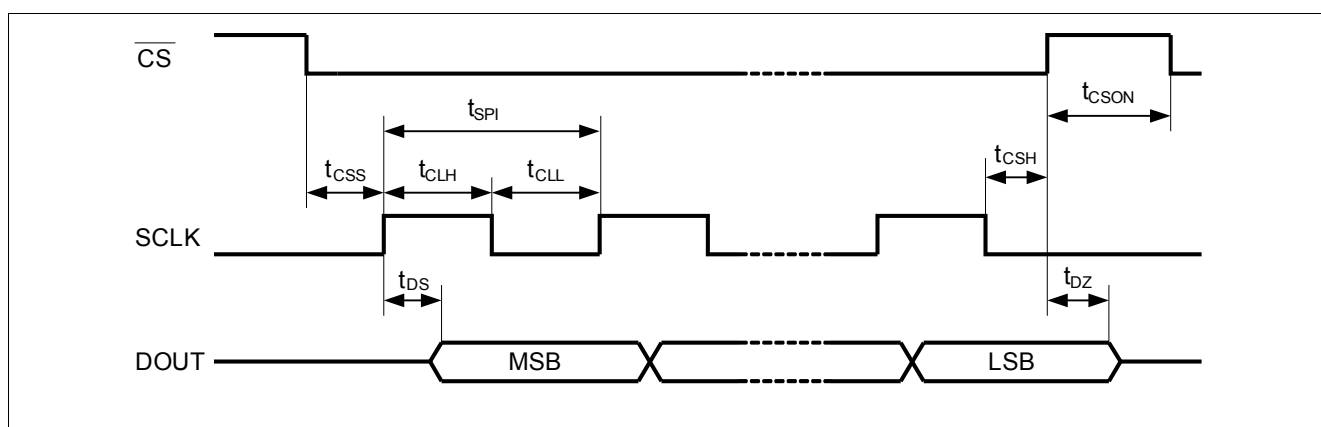


Figure 4-1 SPI interface timing: Readout of sensor data

Table 4-1 Interface Timing Parameters¹⁾ (5MHz SPI clock speed)

General conditions (unless otherwise specified): $V_{DD} = 3.3 \text{ V}$; $T_A = -40 \text{ }^{\circ}\text{C} \dots +85 \text{ }^{\circ}\text{C}$

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
SPI speed (1 / bit time)	f_{SPI}	-	-	5	MHz	Duty cycle ratio 45% ... 55%
SPI period	t_{SPI}	200	-	-	ns	
SCLK duty cycle	$t_{\text{CLH}} / t_{\text{CLL}}$	45	-	55	%	
$\overline{\text{CS}}$ setup time	t_{CSS}	95	-	-	ns	$R_L \geq 100 \text{ k}\Omega$ $C_L \leq 50 \text{ pF}$ to GND
$\overline{\text{CS}}$ hold time	t_{CSH}	95	-	-	ns	$R_L \geq 100 \text{ k}\Omega$ $C_L \leq 50 \text{ pF}$ to GND
Data setup time	t_{DS}	-	-	65	ns	
Delay between $\overline{\text{CS}}$ rising edge and end of DOUT data	t_{DZ}	-	-	75	ns	
$\overline{\text{CS}}$ high time	t_{CSOH}	300	-	-	ns	

1) All timing parameters are valid on the sensor pin with the specified test load only. Different loading due to PCB mounting might result in different timing.

Table 4-2 Interface Electrical Characteristics (5MHz SPI clock speed)

General conditions (unless otherwise specified): $V_{DD} = 3.3 \text{ V}$; $T_A = -40 \text{ }^{\circ}\text{C} \dots +85 \text{ }^{\circ}\text{C}$

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Output level low (SPI)	V_{OL}	-	-	$0.2 \times V_{\text{DD}}$	V	Resistive load; 1 mA to GND
Output level high (SPI)	V_{OH}	$0.8 \times V_{\text{DD}}$	-	-	ns	Resistive load; 1 mA to GND
Input level low (SPI)	V_{IL}	-0.1	-	$0.3 \times V_{\text{DD}}$	V	
Input level high (SPI)	V_{IH}	$0.7 \times V_{\text{DD}}$	-	V_{DD}	V	
Input level hysteresis (SPI)		$0.05 \times V_{\text{DD}}$	-	-	V	
Input capacitance	C_{I}	-	-	100	pF	For all digital input pins
Input resistance	R_{I}	100	-	-	k Ω	For all digital input pins
Load capacitance	C_{L}	-	-	50	pF	To GND; For all digital output pins
Load resistance	R_{L}	100	-	-	k Ω	To V_{DD} ; For all digital output pins

4.2 Serial Inspection and Configuration Interface (SICI)

The serial inspection and configuration interface is only used for EEPROM programming. This interface is a one wire interface provided by a double seizure of the OCD pin. To guarantee a proper SICI communication current must not flow through the primary conductor (to avoid interferences with potential over current detection). The instruction for the serial inspection and configuration interface can be found in the TLI4970 programming guide.

5 Package

The TL14970-D025T4 is packaged in a RoHS compliant, halogen-free leadless package (QFN-like).

5.1 PG-TISON-8-1 Package Outline

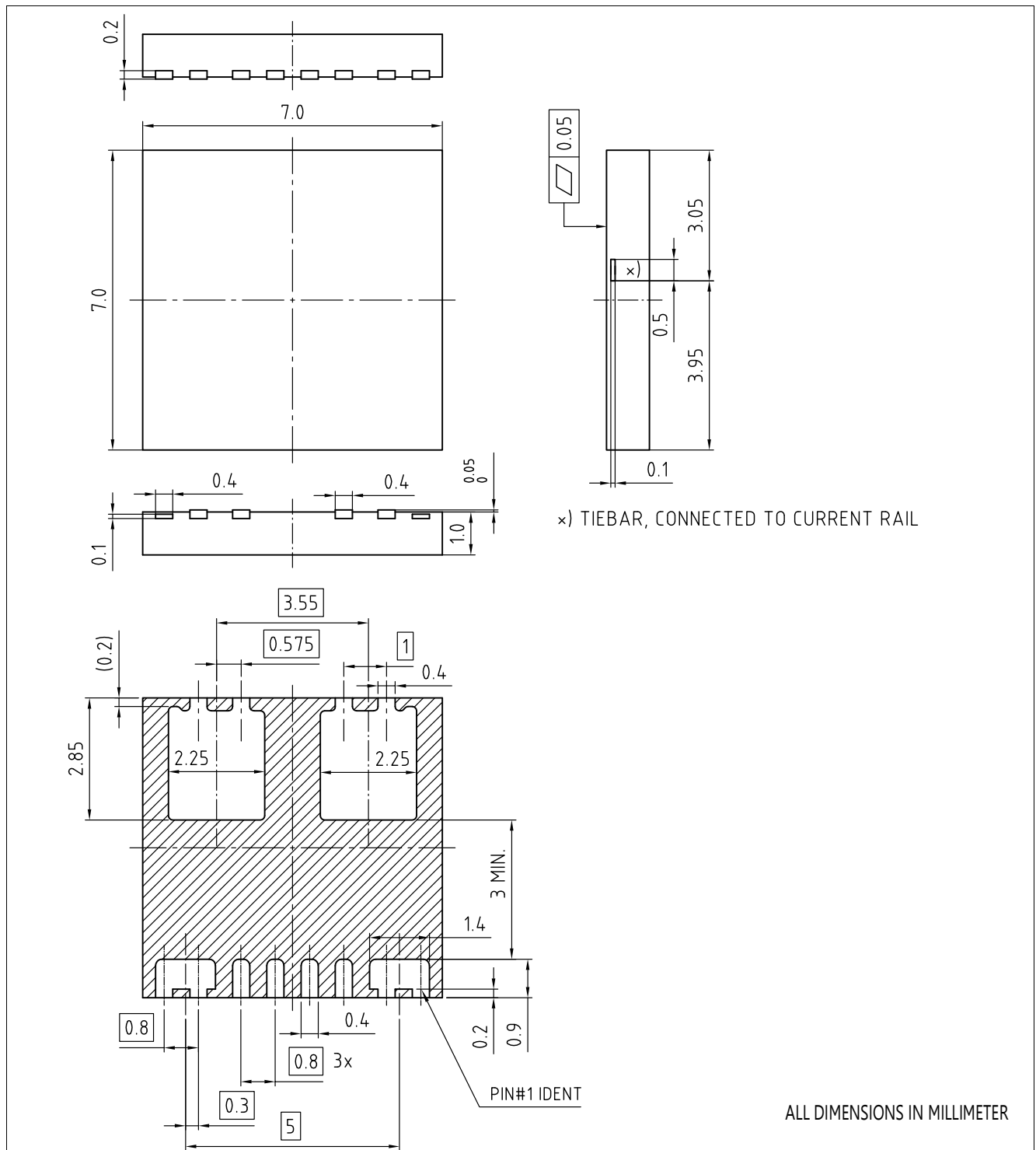


Figure 5-1 PG-TISON-8-1 package dimensions

5.2 Packing

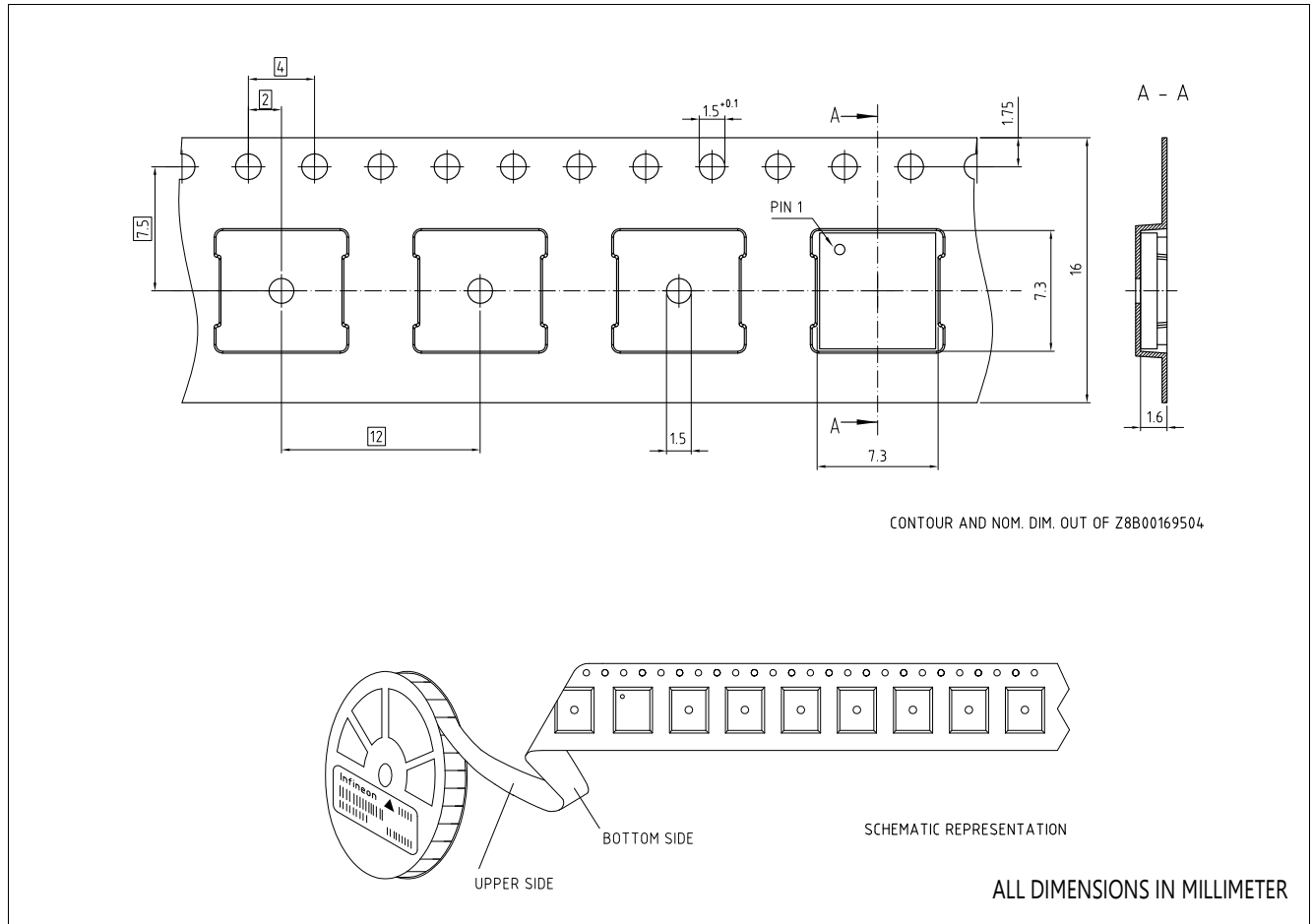


Figure 5-2 Carrier tape of the PG-TISON-8-1 package

5.3 Footprint Recommendation

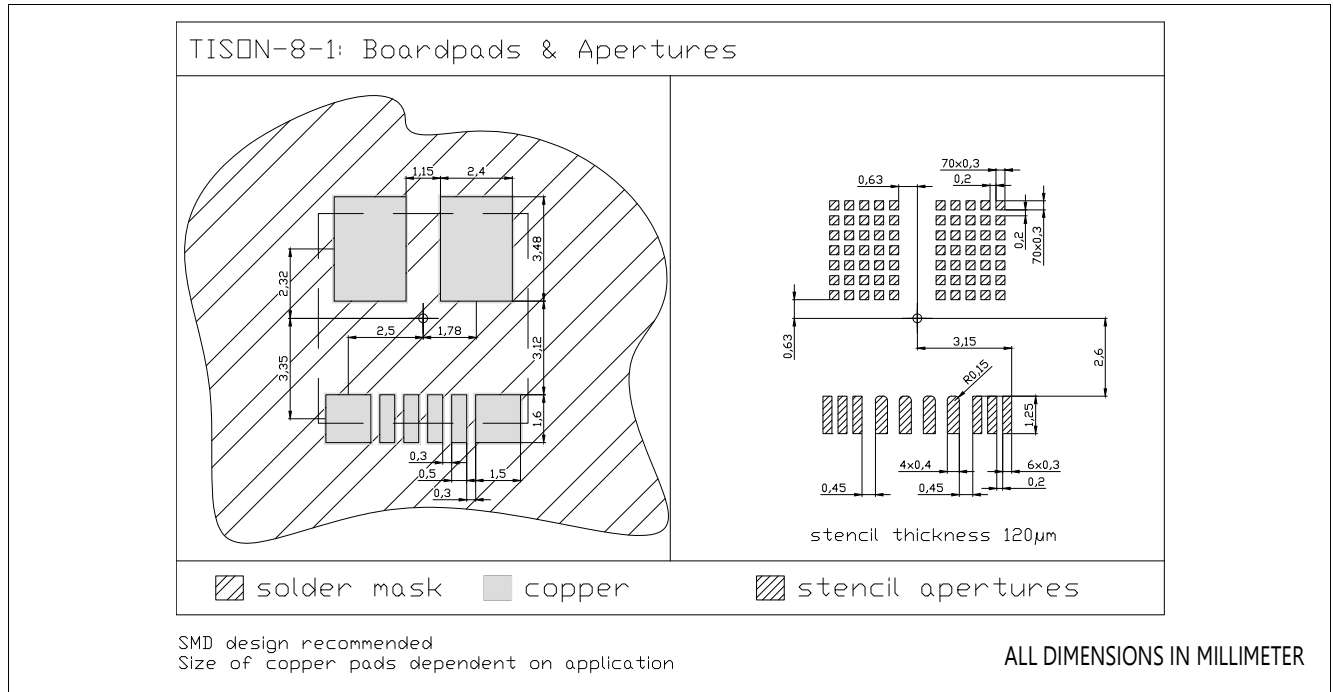


Figure 5-3 Footprint recommendation for reflow soldering

5.4 PCB Layout Recommendation

The PCB layout recommendation shown in [Figure 5.4](#) leads to the preferred current flow through the housing to achieve the highest accuracy.

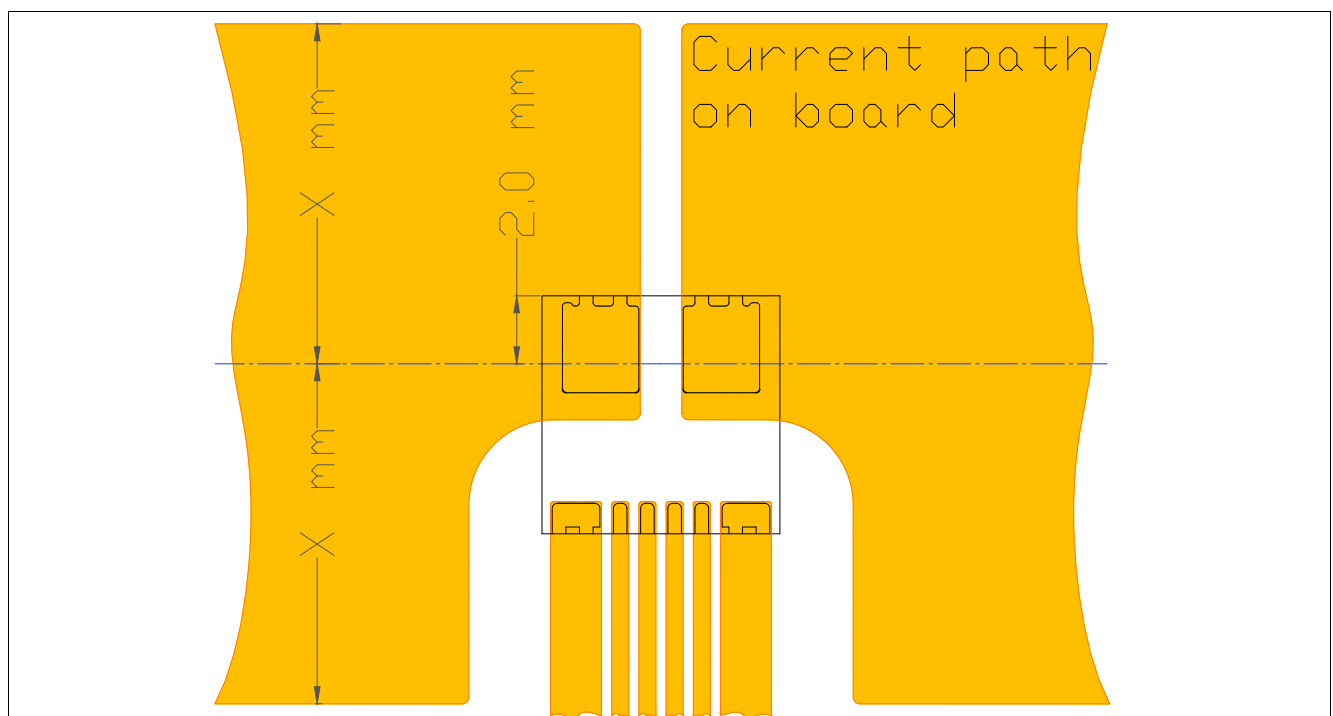


Figure 5-4 PCB layout recommendation

5.5 Laser Marking

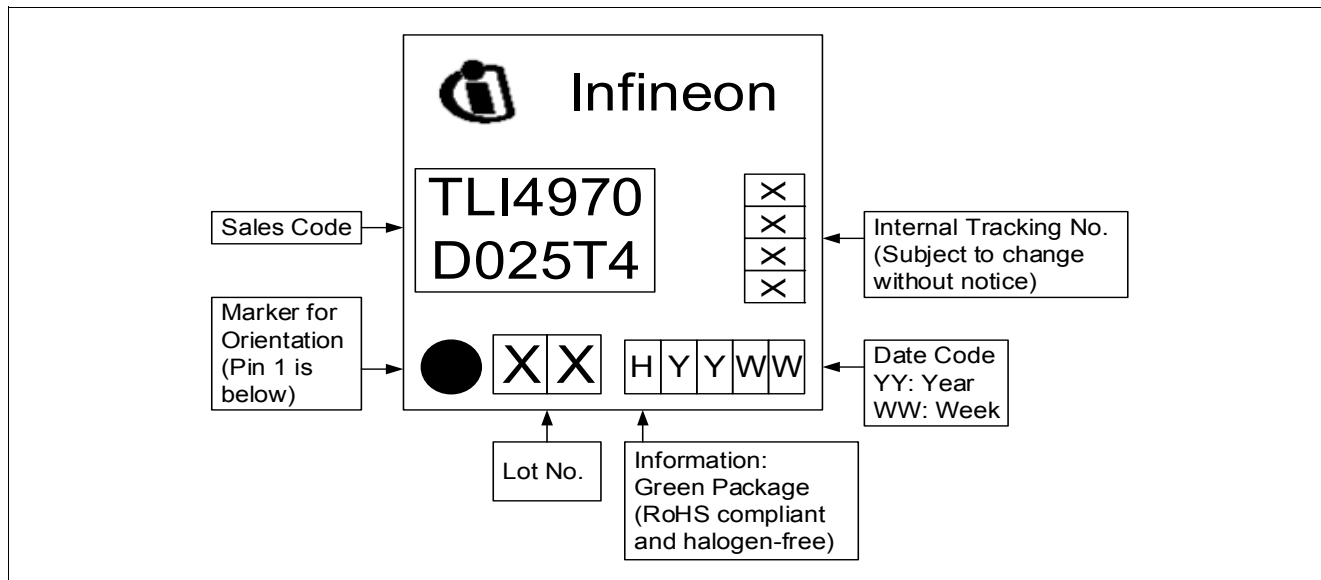


Figure 5-5 Laser marking on the top side

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